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C2-27140-1

ASSIGNMENT OF UNITED STATES APPLICATION FOR PATENT

UNFILED APPLICATION-MULTIPLE INVENTORS

	on Modified inventorio
Whereas the undersigned (1) Hyun Woong have invented certain improvements in "ELEMENT"	SHIM , (2) Bon Seong KOO , and (3) ISOLATION METHOD FOR SEMICONDUCTOR DEVICES'
for which an application for Letters Patent of the Uni	ted States of America:
X was executed on even date herweith	
was filed onand was assigned Applicati	
	Co., Ltd., (hereinafter referred to as Assignee) a corporation mi-ri, Bubal-eub, Ichon-shi, Kyoungki-do, Korea, is etters
the receipt of which is hereby acknowledge, the under unto the said Assignee, for the territory of the Unite said invention and application, and any and all divise Patent that my be granted therefor together with any held and enjoyed by the Assignee for Assignee's own successors and assigns, to the full end of the term for entirely as the same would have been held by the unand the udnersigned, and legal representatives thereof and all paters, and do all lawful acts that said Assigns aid invention and to obtain Letters Patent therefor, said Assignee, Assignee's successors, and agree at Assignee's successors and assigns, such facts relating opposition as may be known to the undersigned and other litigation, when requested to do so, all with expense of the said Assignee, Assignee's successors of the said Assignee.	Dollare (S1.00) and other good and valuable consideration, ersigned by these presents, hereby assing, sell and transfer ed States of America, all right, title and interest in and to sions or continuations thereof, and in and to any Letters by reissues, extensions or renewals thereof, the same to be in use and behoof, and for Assignee's legal representatives, for which said Letters Patent may be granted, as fully and indersigned had this Assignment and same nto been made; of, hereby covenant and agree to execute and deliver any nee may consider necessary or advisable to perfect title to and agree at any time upon request, to communicate to any time upon request, to communicate to said Assignee, age to said invetnion and letters Patent or the interferences, testify as to the same in any interferences, opposition or out further consideration than that now paid, but at the or assigns. REID & PRIEST L.L.P. to insert into this Assignment
	his patent application, such as its title, filing date and
Shi	June 17, 1999
First Inventor Hyun Woong SHIM	Date
	June 17, 1999
Second Inventor Bon Scong KOO	Date
Third Inventor	Date

THELEN REID & PRIEST L.L.P.
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Fourth Inventor

RECORDED: 06/29/1999

PATENT REEL: 010089 FRAME: 0575

Date